



The Organizing Committee  
of  
JSPM International Conference  
On Powder and Powder Metallurgy, 2023, Kyoto

*presents*

Poster Award for  
Outstanding Presentation

*to*

**Eri Takahashi**

Tokyo City University

*for the paper entitled*

**“Fabrication and evaluation of the high-temperature  
bending strength for  $\text{Mo}_2\text{NiB}_2\text{-Ni}$  cermets”**

*October 18, 2023*

Chair of Organizing Committee of JSPMIC2023

**Kazuyoshi YOSHIMUA**

A handwritten signature in black ink, appearing to read 'K. Yoshimua'.

Chair of Program Committee of JSPMIC2023

**Hideaki MATSUBARA**

A handwritten signature in black ink, appearing to read 'Hideaki Matsubara'.